

# Electronic Acknowledgement Receipt

<b>EFS ID:</b>	3309917
<b>Application Number:</b>	10596387
<b>International Application Number:</b>	
<b>Confirmation Number:</b>	5987
<b>Title of Invention:</b>	Epoxy Resin Molding Material for Sealing and Electronic Component
<b>First Named Inventor/Applicant Name:</b>	Kazuyoshi Tendou
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<b>Filer Authorized By:</b>	Joerg-Uwe V. Szipl
<b>Attorney Docket Number:</b>	MIYOSH0006
<b>Receipt Date:</b>	15-MAY-2008
<b>Filing Date:</b>	13-APR-2007
<b>Time Stamp:</b>	16:18:11
<b>Application Type:</b>	U.S. National Stage under 35 USC 371

## Payment information:

Submitted with Payment	no
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## File Listing:

Document Number	Document Description	File Name	File Size(Bytes) /Message Digest	Multi Part /.zip	Pages (if appl.)
1	Information Disclosure Statement Letter	08-05-15_IDS_with_cert.pdf	71459 d502ce23715ff884284351d2bfeca3e09 23c2177	no	3

## Warnings:

## Information:

2	Information Disclosure Statement (IDS) Filed	08-05-15_US_IDS_Form_S B_08a.pdf	660337 1012d6a1ff1db79b4968045359a9eee 62aedd85	no	4
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**Warnings:**

**Information:**

A U.S. Patent Number Citation or a U.S. Publication Number Citation is required in the Information Disclosure Statement (IDS) form for autoloading of data into USPTO systems. You may remove the form to add the required data in order to correct the Informational Message if you are citing U.S. References. If you chose not to include U.S. References, the image of the form will be processed and be made available within the Image File Wrapper (IFW) system. However, no data will be extracted from this form. Any additional data such as Foreign Patent Documents or Non-Patent Literature will be manually reviewed and keyed into USPTO systems.

3	NPL Documents	08-05-15_NPL01_Office_acti on.pdf	485677 52909c6df10d282a717860aac1faec4e 363b3679	no	10
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If a new application is being filed and the application includes the necessary components for a filing date (see 37 CFR 1.53(b)-(d) and MPEP 506), a Filing Receipt (37 CFR 1.54) will be issued in due course and the date shown on this Acknowledgement Receipt will establish the filing date of the application.

**National Stage of an International Application under 35 U.S.C. 371**

If a timely submission to enter the national stage of an international application is compliant with the conditions of 35 U.S.C. 371 and other applicable requirements a Form PCT/DO/EO/903 indicating acceptance of the application as a national stage submission under 35 U.S.C. 371 will be issued in addition to the Filing Receipt, in due course.

**New International Application Filed with the USPTO as a Receiving Office**

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